

ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of Invention

Stacked Die in die BGA Package

Application Number : 10/068159
Confirmation Number: 8043
First Named Applicant: Hock Tan
Attorney Docket Number: MTI-31608
Art Unit: 2818
Examiner: Thao P. Le
Search string: (5323060 or 6051886 or 20020096754).pn



US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
	1	5323060	1994-06-21	Fogal et al.		257	777
	2	6051886	2000-04-18	Fogal et al.		257	777

US Published Applications

Note: Applicant is not required to submit a paper copy of cited US Published Applications

init	Cite.No.	Pub. No.	Date	Applicant	Kind	Class	Subclass
	1	20020096754	2002-07-25	Chen et al.	A1	257	686

Signature

Examiner Name	Date